## Errata

# MSP430F5131 Microcontroller



### **ABSTRACT**

This document describes the known exceptions to the functional specifications (advisories).

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## 1 Functional Advisories

Advisories that affect the device's operation, function, or parametrics.

√ The check mark indicates that the issue is present in the specified revision.

	ပ
Errata Number	Rev C
COMP10	<b>√</b>
CPU46	✓
CPU47	✓
DMA4	✓
DMA7	✓
DMA10	✓
PMAP1	✓
PMM14	✓
PMM15	✓
PMM18	✓
PMM20	✓
PMM26	✓
PORT15	✓
PORT19	✓
PORT21	✓
SYS12	✓
SYS16	✓
TD1	✓
TD2	✓
UCS9	✓
UCS11	✓
USCI26	
USCI31	✓
USCI34	✓
USCI35	✓
USCI39	✓
USCI40	✓

## 2 Preprogrammed Software Advisories

Advisories that affect factory-programmed software.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev C
BSL7	✓

## 3 Debug Only Advisories

Advisories that affect only debug operation.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev C
EEM11	1



Errata Number	Rev C
EEM17	1
EEM19	✓
EEM21	✓
EEM23	✓
JTAG26	✓
JTAG27	✓

## 4 Fixed by Compiler Advisories

Advisories that are resolved by compiler workaround. Refer to each advisory for the IDE and compiler versions with a workaround.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev C
CPU21	1
CPU22	✓
CPU40	✓

Refer to the following MSP430 compiler documentation for more details about the CPU bugs workarounds.

### TI MSP430 Compiler Tools (Code Composer Studio IDE)

- MSP430 Optimizing C/C++ Compiler: Check the --silicon\_errata option
- MSP430 Assembly Language Tools

### MSP430 GNU Compiler (MSP430-GCC)

- MSP430 GCC Options: Check -msilicon-errata= and -msilicon-errata-warn= options
- MSP430 GCC User's Guide

### IAR Embedded Workbench

• IAR workarounds for msp430 hardware issues



## 5 Nomenclature, Package Symbolization, and Revision Identification

The revision of the device can be identified by the revision letter on the Package Markings or by the HW\_ID located inside the TLV structure of the device.

### 5.1 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP MCU devices. Each MSP MCU commercial family member has one of two prefixes: MSP or XMS. These prefixes represent evolutionary stages of product development from engineering prototypes (XMS) through fully qualified production devices (MSP).

**XMS** – Experimental device that is not necessarily representative of the final device's electrical specifications

MSP - Fully qualified production device

Support tool naming prefixes:

X: Development-support product that has not yet completed Texas Instruments internal qualification testing.

null: Fully-qualified development-support product.

XMS devices and X development-support tools are shipped against the following disclaimer:

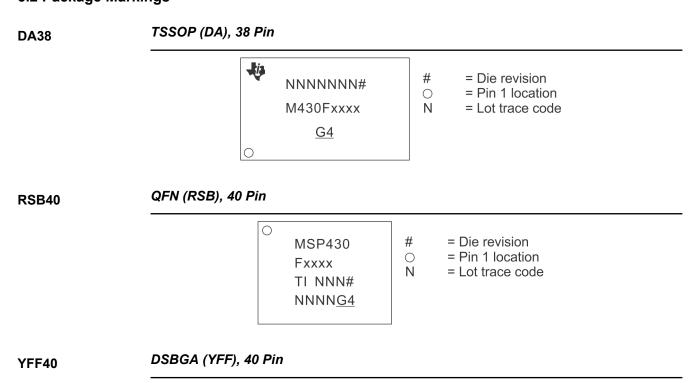
"Developmental product is intended for internal evaluation purposes."

MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. Tl's standard warranty applies.

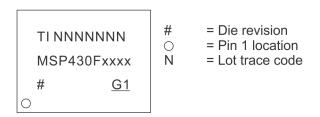
Predictions show that prototype devices (XMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format.

### 5.2 Package Markings







## **5.3 Memory-Mapped Hardware Revision (TLV Structure)**

Die Revision	TLV Hardware Revision	
Rev C	30h	

Further guidance on how to locate the TLV structure and read out the HW\_ID can be found in the device User's Guide.

## **6 Advisory Descriptions**

BSL7 BSL Module

**Category** Software in ROM

**Function** BSL does not start after waking up from LPMx.5

**Description** When waking up from LPMx.5 mode, the BSL does not start as it does not clear the Lock

I/O bit (LOCKLPM5 bit in PM5CTL0 register) on start-up.

Workaround 1. Upgrade the device BSL to the latest version (see Creating a Custom Flash-Based

Bootstrap Loader (BSL) Application Note - SLAA450 for more details)

OR

2. Do not use LOCKLPM5 bit (LPMx.5) if the BSL is used but cannot be upgraded.

COMP10 COMP Module

**Category** Functional

**Function** Comparator port output toggles when entering or leaving LPM3/LPM4

**Description** The comparator port pin output (CECTL1.CEOUT) erroneously toggles when device

enters or leaves LPM3/LPM4 modes under the following conditions:

1) Comparator is disabled (CECTL1.CEON = 0)

AND

2) Output polarity is enabled (CECTL1.CEOUTPOL = 1)

AND

3) The port pin is configured to have CEOUT functionality.

For example, if the CEOUT pin is high when the device is in Active Mode, CEOUT pin

becomes low when the device enters LPM3/LPM4 modes.

Workaround When the comparator is disabled, ensure at least one of the following:

1) Output inversion is disabled (CECTL.CEOUTPOL = 0)

OR

2) Change pin configuration from CEOUT to GPIO with output low.

CPU21 CPU Module

Category Compiler-Fixed

**Function** Using POPM instruction on Status register may result in device hang up

**Description** When an active interrupt service request is pending and the POPM instruction is used to

set the Status Register (SR) and initiate entry into a low power mode, the device may

hang up.

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#### Workaround

None. It is recommended not to use POPM instruction on the Status Register.

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	Not affected	
TI MSP430 Compiler Tools (Code Composer Studio)	v4.0.x or later	User is required to add the compiler or assembler flag option below silicon_errata=CPU21
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 167 or later	

CPU22 CPU Module

Category

Compiler-Fixed

**Function** 

Indirect addressing mode with the Program Counter as the source register may produce unexpected results

**Description** 

When using the indirect addressing mode in an instruction with the Program Counter (PC) as the source operand, the instruction that follows immediately does not get executed. For example in the code below, the ADD instruction does not get executed.

mov @PC, R7 add #1h, R4

#### Workaround

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	Not affected	
TI MSP430 Compiler Tools (Code Composer Studio)	v4.0.x or later	User is required to add the compiler or assembler flag option below silicon_errata=CPU22
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 167 or later	

CPU40 CPU Module

Category

Compiler-Fixed

**Function** 

PC is corrupted when executing jump/conditional jump instruction that is followed by instruction with PC as destination register or a data section

**Description** 

If the value at the memory location immediately following a jump/conditional jump instruction is 0X40h or 0X50h (where X = don't care), which could either be an instruction opcode (for instructions like RRCM, RRAM, RLAM, RRUM) with PC as destination register or a data section (const data in flash memory or data variable in RAM), then the PC value is auto-incremented by 2 after the jump instruction is executed; therefore, branching to a wrong address location in code and leading to wrong program execution.



For example, a conditional jump instruction followed by data section (0140h).

@0x8012 Loop DEC.W R6

@0x8014 DEC.W R7 @0x8016 JNZ Loop

@0x8018 Value1 DW 0140h

#### Workaround

In assembly, insert a NOP between the jump/conditional jump instruction and program code with instruction that contains PC as destination register or the data section.

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	IAR EW430 v5.51 or later	For the command line version add the following information Compiler:hw_workaround=CPU40 Assembler:-v1
TI MSP430 Compiler Tools (Code Composer Studio)	v4.0.x or later	User is required to add the compiler or assembler flag option below silicon_errata=CPU40
MSP430 GNU Compiler (MSP430-GCC)	Not affected	

## CPU46 CPU Module

Category

**Functional** 

**Function** 

POPM peforms unexpected memory access and can cause VMAIFG to be set

**Description** 

When the POPM assembly instruction is executed, the last Stack Pointer increment is followed by an unintended read access to the memory. If this read access is performed on vacant memory, the VMAIFG will be set and can trigger the corresponding interrupt (SFRIE1.VMAIE) if it is enabled. This issue occurs if the POPM assembly instruction is performed up to the top of the STACK.

### Workaround

If the user is utilizing C, they will not be impacted by this issue. All TI/IAR/GCC pre-built libraries are not impacted by this bug. To ensure that POPM is never executed up to the memory border of the STACK when using assembly it is recommended to either

- 1. Initialize the SP to
- a. TOP of STACK 4 bytes if POPM.A is used
- b. TOP of STACK 2 bytes if POPM.W is used

OR

2. Use the POPM instruction for all but the last restore operation. For the last restore operation use the POP assembly instruction instead.

For instance, instead of using:

POPM.W #5,R13



#### Use:

POPM.W #4,R12 POP.W R13

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	Not affected	C code is not impacted by this bug. User using POPM instruction in assembler is required to implement the above workaround manually.
TI MSP430 Compiler Tools (Code Composer Studio)	Not affected	C code is not impacted by this bug. User using POPM instruction in assembler is required to implement the above workaround manually.
MSP430 GNU Compiler (MSP430-GCC)	Not affected	C code is not impacted by this bug. User using POPM instruction in assembler is required to implement the above workaround manually.

**CPU Module** CPU47

Category **Functional** 

**Function** An unexpected Vacant Memory Access Flag (VMAIFG) can be triggered

**Description** An unexpected Vacant Memory Access Flag (VMAIFG) can be triggered, if a PC-

> modifying instruction (e.g. - ret, push, call, pop, jmp, br) is fetched from the last addresses (last 4 or 8 byte) of a memory (e.g.- FLASH, RAM, FRAM) that is not contiguous to a

higher, valid section on the memory map.

In debug mode using breakpoints the last 8 bytes are affected.

In free running mode the last 4 bytes are affected.

Workaround Edit the linker command file to make the last 4 or 8 bytes of affected memory sections

unavailable, to avoid PC-modifying instructions on these locations.

Remaining instructions or data can still be stored on these locations.

**DMA Module** DMA4

Category **Functional** 

**Function** Corrupted write access to 20-bit DMA registers

**Description** When a 20-bit wide write to a DMA address register (DMAxSA or DMAxDA) is interrupted

by a DMA transfer, the register contents may be unpredictable.

Workaround 1. Design the application to guarantee that no DMA access interrupts 20-bit wide

accesses to the DMA address registers.

OR



2. When accessing the DMA address registers, enable the Read Modify Write disable bit (DMARMWDIS = 1) or temporarily disable all active DMA channels (DMAEN = 0).

OR

3. Use word access for accessing the DMA address registers. Note that this limits the values that can be written to the address registers to 16-bit values (lower 64K of Flash).

DMA7 DMA Module

**Category** Functional

**Function** DMA request may cause the loss of interrupts

**Description**If a DMA request starts executing during the time when a module register containing an interrupt flags is accessed with a read-modify-write instruction, a newly arriving interrupt from the same module can get lost. An interrupt flag set prior to DMA execution would not

be affected and remain set.

**Workaround**1. Use a read of Interrupt Vector registers to clear interrupt flags and do not use read-modify-write instruction.

OR

2. Disable all DMA channels during read-modify-write instruction of specific module registers containing interrupts flags while these interrupts are activated.

DMA10 DMA Module

Category Functional

**Function** DMA access may cause invalid module operation

**Description** The peripheral modules MPY, CRC, USB, RF1A and FRAM controller in manual mode

can stall the CPU by issuing wait states while in operation. If a DMA access to the module occurs while that module is issuing a wait state, the module may exhibit undefined

behavior.

Workaround Ensure that DMA accesses to the affected modules occur only when the modules are

not in operation. For example with the MPY module, ensure that the MPY operation is

completed before triggering a DMA access to the MPY module.

EEM11 EEM Module

Category Debug

**Function** Conditional register write trigger fails while executing rotate instructions

**Description** A conditional register write trigger will fail to generate the expected breakpoint if

the trigger condition is a result of executing one of the following rotate instructions:

RRUM, RRCM, RRAM and RLAM.

Workaround None



Note

This erratum applies to debug mode only.

EEM17 EEM Module

**Category** Debug

Function Wrong Breakpoint halt after executing Flash Erase/Write instructions

**Description** Hardware breakpoints or Conditional Address triggered breakpoints on instructions that

follow Flash Erase/Write instructions, stops the debugger at the actual Flash Erase/Write instruction even though the flash erase/write operation has already been executed. The hardware/conditional address triggered breakpoints that are placed on either the next two single opcode instructions OR the next double opcode instruction that follows the Flash

Erase/Write instruction are affected by this erratum.

Workaround None. Use other conditional/advanced triggered breakpoints to halt the debugger right

after Flash erase/write instructions.

Note

This erratum affects debug mode only.

EEM19 EEM Module

Category Debug

**Function** DMA may corrupt data in debug mode

**Description** When the DMA is enabled and the device is in debug mode, the data written by the DMA

may be corrupted when a breakpoint is hit or when the debug session is halted.

Workaround This erratum has been addressed in MSPDebugStack version 3.5.0.1. It is also available

in released IDE EW430 IAR version 6.30.3 and CCS version 6.1.1 or newer.

If using an earlier version of either IDE or MSPDebugStack, do not halt or use breakpoints

during a DMA transfer.

Note

This erratum applies to debug mode only.

EEM21 EEM Module

**Category** Debug

**Function** LPMx.5 debug limitations

**Description** Debugging the device in LPMx.5 mode might wake the device up from LPMx.5 mode

inadvertently, and it is possible that the device enters a lock-up condition; that is, the

device cannot be accessed by the debugger any more.

Workaround Follow the debugging steps in Debugging MSP430 LPM4.5 SLAA424.



EEM23 EEM Module

**Category** Debug

**Function** EEM triggers incorrectly when modules using wait states are enabled

**Description** When modules using wait states (USB, MPY, CRC and FRAM controller in manual mode)

are enabled, the EEM may trigger incorrectly. This can lead to an incorrect profile counter value or cause issues with the EEMs data watch point, state storage, and breakpoint

functionality.

Workaround None.

Note

This erratum affects debug mode only.

JTAG26 JTAG Module

**Category** Debug

Function LPMx.5 Debug Support Limitations

**Description** The JTAG connection to the device might fail at device-dependent low or high supply

voltage levels if the LPMx.5 debug support feature is enabled. To avoid a potentially unreliable debug session or general issues with JTAG device connectivity and the resulting bad customer experience Texas Instruments has chosen to remove the LPMx.5 debug support feature from common MSP430 IDEs including TIs Code Composer Studio 6.1.0 with msp430.emu updated to version 6.1.0.7 and IARs Embedded Workbench 6.30.2, which are based on the MSP430 debug stack MSP430.DLL 3.5.0.1 http://

www.ti.com/tool/MSPDS

TI plans to re-introduce this feature in limited capacity in a future release of the debug stack by providing an IDE override option for customers to selectively re-activate LPMx.5 debug support if needed. Note that the limitations and supply voltage dependencies outlined in this erratum will continue to apply.

For additional information on how the LPMx.5 debug support is handled within the MSP430 IDEs including possible workarounds on how to debug applications using LPMx.5 without toolchain support refer to Code Composer Studio User's Guide for MSP430 chapter F.4 and IAR Embedded Workbench User's Guide for MSP430 chapter 2.2.5.

Workaround

- 1. If LPMx.5 debug support is deemed functional and required in a given scenario:
- a) Do not update the IDE to continue using a previous version of the debug stack such as MSP430.DLL  $\nu$ 3.4.3.4.

OR

- b) Roll back the debug stack by either performing a clean re-installation of a previous version of the IDE or by manually replacing the debug stack with a prior version such as MSP430.DLL v3.4.3.4 that can be obtained from http://www.ti.com/tool/MSPDS.
- 2. In case JTAG connectivity fails during the LPMx.5 debug mode, the device supply voltage level needs to be raised or lowered until the connection is working.



Do not enable the LPMx.5 debug support feature during production programming.

JTAG27 JTAG Module

**Category** Debug

Function Unintentional code execution after programming via JTAG/SBW

**Description**The device can unintentionally start executing code from uninitialized RAM addresses 0x0006 or 0x0008 after being programming via the JTAG or SBW interface. This can

result in unpredictable behavior depending on the contents of the address location.

Workaround

1. If using programming tools purchased from TI (MSP-FET, LaunchPad), update to CCS version 6.1.3 later or IAR version 6.30 or later to resolve the issue.

2. If using the MSP-GANG Production Programmer, use v1.2.3.0 or later.

3. For custom programming solutions refer to the specification on MSP430 Programming Via the JTAG Interface User's Guide (SLAU320) revision V or newer and use MSPDebugStack v3.7.0.12 or later.

For MSPDebugStack (MSP430.DLL) in CCS or IAR, download the latest version of the development environment or the latest version of the MSPDebugStack

NOTE: This only affects debug mode.'

### PMAP1 PMAP Module

**Category** Functional

**Function** Port Mapping Controller does not clear unselected inputs to mapped module.

Description

The Port Mapping Controller provides the logical OR of all port mapped inputs to a module (Timer, USCI, etc). If the PSEL bit (PxSEL.y) of a port mapped input is cleared, then the logic level of that port mapped input is latched to the current logic level of the input. If the input is in a logical high state, then this high state is latched into the input of the logical OR. In this case, the input to the module is always a logical 1 regardless of the state of the selected input.

Workaround

1. Drive input to the low state before clearing the PSEL bit of that input and switching to another input source.

or

2. Use the Port Mapping Controller reconfiguration feature, PMAPRECFG, to select inputs to a module and map only one input at a time.

PMM14 PMM Module

Category Functional

**Function** Increasing the core level when SVS/SVM low side is configured in full-performance mode

causes device reset

**Description** When the SVS/SVM low side is configured in full performance mode

(SVSMLCTL.SVSLFP = 1), the setting time delay for the SVS comparators is ~2us. When increasing the core level in full-performance mode; the core voltage does not settle to the

new level before the settling time delay of the SVS/SVM comparator expires. This results in a device reset.

#### Workaround

When increasing the core level; enable the SVS/SVM low side in normal mode (SVSMLCTL.SVSLFP=0). This provides a settling time delay of approximately 150us allowing the core sufficient time to increase to the expected voltage before the delay expires.

**PMM15** 

### PMM Module

Category

**Functional** 

**Function** 

Device may not wake up from LPM2, LPM3, or LPM4

**Description** 

Device may not wake up from LPM2, LPM3 or LMP4 if an interrupt occurs within 1 us after the entry to the specified LPMx; entry can be caused either by user code or automatically (for example, after a previous ISR is completed). Device can be recovered with an external reset or a power cycle. Additionally, a PUC can also be used to reset the failing condition and bring the device back to normal operation (for example, a PUC caused by the WDT).

This effect is seen when:

- A write to the SVSMHCTL and SVSMLCTL registers is immediately followed by an LPM2, LPM3, LPM4 entry without waiting the requisite settling time ((PMMIFG.SVSMLDLYIFG = 0 and PMMIFG.SVSMHDLYIFG = 0)).

or

The following two conditions are met:

- The SVSL module is configured for a fast wake-up or when the SVSL/SVML module is turned off. The affected SVSMLCTL register settings are shaded in the following table.

	SVSLE	SVSLMD	SVSLFP	AM, LPM0/1 SVSL state	Manual SVSMLACE = 0 LPM2/3/4 SVSL State	Automatic SVSMLACE = 1 LPM2/3/4 SVSL State	Wakeup Time LPM2/3/4
SVSL	0	X	Х	OFF	OFF	OFF	twake-up fast
	1	0	0	Normal	OFF	OFF	twake-up slow
	1	0	1	Full Performance	OFF	OFF	twake-up fast
	1	1	0	Normal	Normal	OFF	twake-up slow
	1	1	1	Full Performance	Full Performance	Normal	twake-up fast
	SVMLE	SVM	LFP	AM, LPM0/1	Manual SVSMLACE = 0	Automatic SVSMLACE = 1	Wakeup Time
SVML				SVML state	LPM2/3/4 SVML State	LPM2/3/4 SVML State	LPM2/3/4
	0	×	(	OFF	OFF	OFF	twake-up fast
	1	C	)	Normal	Normal	OFF	twake-up slow
1	1 1		Full Performance	Full Performance	Nomal	twake-up fast	

and

-The SVSH/SVMH module is configured to transition from Normal mode to an OFF state when moving from Active/LPM0/LPM1 into LPM2/LPM3/LPM4 modes. The affected SVSMHCTL register settings are shaded in the following table.



svsh	SVSHE	SVSHMD	SVSHFP	AM, LPM0/1 SVSH state	Manual SVSMHACE = 0	Automatic SVSMHACE = 1
					LPM2/3/4 SVSH State	LPM2/3/4 SVSH State
	0	×	×	OFF	OFF	OFF
	1	0	0	Normal	OFF	OFF
	1	0	1	Full Performance	OFF	OFF
	1	1	0	Normal	Normal	OFF
	1	1	1	Full Performance	Full Performance	Normal
SVMH	SVMHE	SVMHFP		AM, LPMO/1 SVMH state	Manual SVSMHACE = 0	Automatic SVSMHACE = 1
					LPM2/3/4 SVMH State	LPM2/3/4 SVMH State
	0	x		OFF	OFF	OFF
	1	0		Normal	Normal	OFF
	1	1		Full Performance	Full Performance	Normal

#### Workaround

Any write to the SVSMxCTL register must be followed by a settling delay (PMMIFG.SVSMLDLYIFG = 0 and PMMIFG.SVSMHDLYIFG = 0) before entering LPM2, LPM3, LPM4.

and

- 1. Ensure the SVSx, SVMx are configured to prevent the issue from occurring by the following:
- Configure the SVSL module for slow wake up (SVSLFP = 0). Note that this will increase the wakeup time from LPM2/3/4 to twakeupslow (~150 us).

or

- Do not configure the SVSH/SVMH such that the modules transition from Normal mode to an OFF state on LPM entry and ensure SVSH/SVMH is in manual mode. Instead force the modules to remain ON even in LPMx. Note that this will cause increased power consumption when in LPMx.

Refer to the MSP430 Driver Library(MSPDRIVERLIB) for proper PMM configuration functions.

Use the following function, PMM15Check (void), to determine whether or not the existing PMM configuration is affected by the erratum. The return value of the function is 1 if the configuration is affected, and 0 if the configuration is not affected.

```
unsigned char PMM15Check (void)
{
// First check if SVSL/SVML is configured for fast wake-up
if ( (!(SVSMLCTL & SVSLE)) || ((SVSMLCTL & SVSLE) && (SVSMLCTL & SVSLFP)) ||
(!(SVSMLCTL & SVMLE)) || ((SVSMLCTL & SVMLE) && (SVSMLCTL & SVMLFP))) )
{
// Next Check SVSH/SVMH settings to see if settings are affected by PMM15
if ((SVSMHCTL & SVSHE) && (!(SVSMHCTL & SVSHFP)))
{
if ( (!(SVSMHCTL & SVSHMD)) || ((SVSMHCTL & SVSHMD) &&
(SVSMHCTL & SVSMHACE)) )
return 1; // SVSH affected configurations
}
if ((SVSMHCTL & SVMHE) && (!(SVSMHCTL & SVMHFP)) && (SVSMHCTL &
SVSMHACE))
return 1; // SVMH affected configurations
}
```



return 0; // SVS/M settings not affected by PMM15
}
}

2. If fast servicing of interrupts is required, add a 150us delay either in the interrupt service routine or before entry into LPM3/LPM4.

**PMM18** 

#### PMM Module

### Category

**Functional** 

**Function** 

PMM supply overvoltage protection falsely triggers POR

**Description** 

The PMM Supply Voltage Monitor (SVM) high side can be configured as overvoltage protection (OVP) using the SVMHOVPE bit of SVSMHCTL register. In this mode a POR should typically be triggered when DVCC reaches ~3.75V.

If the OVP feature of SVM high side is enabled going into LPM234, the SVM might trigger at DVCC voltages below 3.6V (~3.5V) within a few ns after wake-up. This can falsely cause an OVP-triggered POR. The OVP level is temperature sensitive during fail scenario and decreases with higher temperature (85 degC ~3.2V).

Workaround

Use automatic control mode for high-side SVS & SVM (SVSMHCTL.SVSMHACE=1). The SVM high side is inactive in LPM2, LPM3, and LPM4.

## PMM20

#### PMM Module

### Category

**Functional** 

**Function** 

Unexpected SVSL/SVML event during wakeup from LPM2/3/4 in fast wakeup mode

**Description** 

If PMM low side is configured to operate in fast wakeup mode, during wakeup from LPM2/3/4 the internal VCORE voltage can experience voltage drop below the corresponding SVSL and SVML threshold (recommendation according to User's Guide) leading to an unexpected SVSL/SVML event. Depending on PMM configuration, this event triggers a POR or an interrupt.

### Note

As soon the SVSL or the SVML is enabled in Normal performance mode the device is in slow wakeup mode and this erratum does not apply. In addition, this erratum has sporadic characteristic due to an internal asynchronous circuit. The drop of Vcore does not have an impact on specified device performance.

### Workaround

If SVSL or SVML is required for application (to observe external disruptive events at Vcore pin) the slow wakeup mode has to be used to avoid unexpected SVSL/SVML events. This is achieved if the SVSL or the SVML is configured in "Normal" performance mode (not disabled and not in "Full" Performance Mode).

## PMM26 PMM Module

Category Functional

Function Device lock-up if RST pin pulled low during write to SVSMHCTL or SVSMLCTL

**Description** Device results in lock-up condition under one of the two scenarios below:

1) If RST pin is pulled low during write access to SVSMHCTL, with the RST/NMI pin

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is configured to reset function and is pulled low (reset event) the device will stop code execution and is continuously held in reset state. RST pin is no longer functional. The only way to come out of the lock-up situation is a power cycle.

OR

2) If RST pin is pulled low during write access to SVSMLCTL and only if the code that checks for SVSMLDLYIFG==1 is implemented without a timeout. The device will be stuck in the polling loop polling since SVSMLDLYIFG will never be cleared.

#### Workaround

Follow the sequence below to prevent the lock-up for both use cases:

1) Disable RST pin reset function and switch to NMI before access SVSMHCTL or SVSMLCTL.

then

2) Activate NMI interrupt and handle reset events in this time by SW (optional if reset functionality required during access SVSMHCTL or SVSMLCTL)

3) Enable RST pin reset function after access to SVSMHCTL or SVSMLCTL

To prevent lock-up caused by use case #2 a timeout for the SVSMLDLYIFG flag check should be implemented to 300us.

## PORT15 PORT Module

Category Functional

Function In-system debugging causes the PMALOCKED bit to be always set

Description

The port mapping controller registers cannot be modified when single-stepping or halting at break points between a valid password write to the PMAPWD register and the expected lock of the port mapping (PMAP) registers. This causes the PMAPLOCKED bit to remain set and not clear as expected.

Note: This erratum only applies to in-system debugging and is not applicable when operating in free-running mode.

Workaround

Do not single step through or place break points in the port mapping configuration section of code.

PORT19	PORT Module
P()R119	i Oiti modulo

Category Functional

**Function** Port interrupt may be missed on entry to LPMx.5

**Description** If a port interrupt occurs within a small timing window (~1MCLK cycle) of the device entry

into LPM3.5 or LPM4.5, it is possible that the interrupt is lost. Hence this interrupt will not

trigger a wakeup from LPMx.5.

Workaround None

PORT21 PORT Module

**Category** Functional

**Function** Setting PxSEL bit for XTAL pins



**Description** Setting the PxSEL bit of XIN pin does not disable the digital function of the XOUT pin (in

non-bypass mode). The primary port function will still be active on the XOUT pin.

**Workaround** Set the PxSEL bit of XOUT pin explicitly to disable the port function of the XOUT pin.

SYS12 SYS Module

**Category** Functional

**Function** Invalid ACCVIFG when DVcc in the range of 2.4 to 2.6V

**Description** A Flash Access Violation Interrupt Flag (ACCVIFG) may be triggered by the Voltage

Changed During Program Error bit (VPE) when DVcc is in the range of 2.4 to 2.6V.

However the VPE does not signify an invalid flash operation has occurred.

If the ACCVIE bit is set and a flash operation is executed in the affected voltage range, an unnecessary interrupt is requested. The bootstrap loader also cannot be used to execute write/erase flash operations in this voltage range, because it exits the flash operation and

returns an error on an ACCVIFG event.

Workaround None

SYS16 SYS Module

Category Functional

**Function** Fast Vcc ramp after device power up may cause a reset

**Description** At initial power-up, after Vcc crosses the brownout threshold and reaches a constant

level, an abrupt ramp of Vcc at a rate dV/dT > 1V/100us can cause a brownout condition to be incorrectly detected even though Vcc does not fall below the brownout threshold.

This causes the device to undergo a reset.

**Workaround** Use a controlled Vcc ramp to power up the device.

TD1 TD Module

**Category** Functional

**Function** Timer halt on EXTCLR event

**Description** When the TEC module is configured to enable external asynchronous signals on the

TECxCLR (TEC external clear) pin to clear the timer counter on the selected edge and the timer is halted after an external clear event but before next positive edge of the timer clock, then due to the erratum, it is not possible to write to the timer counter (TDxR) until the next positive timer clock edge occurrence. Halting of the timer right after an external clear event is possible if the system clock (MCLK) much greater than the Timer\_D clock and the application halts the timer in the external clear interrupt service routine or if the application is doing random timer halts. This erratum does not cause any dead-lock conditions and the timer counter can be written into when the next positive timer clock

edge is available.

**Workaround** If required to halt the timer and change the timer counter value on an external clear event,

wait until one timer clock period has elapsed to change the timer counter value.

TD2 TD Module



www.ti.com Advisory Descriptions

**Category** Functional

**Function** Up/Down mode with high resolution enabled

**Description** The Timer D Up/Down mode is not functional in high-resolution mode. The PWM signals

are generated incorrectly in the down phase.

Timer D can only be used in Up mode in high-resolution mode.

Workaround None

UCS9 UCS Module

Category Functional

**Function** Digital Bypass mode prevents entry into LPM4

**Description** When entering LPM4, if an external digital input applied to XT1 in HF mode or XT2 is not

turned off, the PMM does not switch to low-current mode causing higher than expected

power consumption.

Workaround Before entering LPM4:

(1) Switch to a clock source other than external bypass digital input.

OR

(2) Turn off external bypass mode (UCSCTL6.XT1BYPASS = 0).

UCS11 UCS Module

Category Functional

Function Modifying UCSCTL4 clock control register triggers an additional erroneous clock request

**Description** Changing the SELM/SELS/SELA bits in the UCSCTL4 register will correctly configure the

respective clock to use the intended clock source but might also erroneously set XT1/XT2 fault flag if the crystals are not present at XT1/XT2 or not configured in the application firmware. If the NMI interrupt for the OFIFG is enabled, an unintentional NMI interrupt will

be triggered and needs to be handled.

Note

The XT1/XT2 fault flag can be set regardless of which SELM/SELS/SELA bit combinations are being changed.

Workaround Clear all the fault flags in UCSCTL7 register once after changing any of the SELM/SELS/

SELA bits in the UCSCTL4 register.

If OFIFG-NMI is enabled during clock switching, disable OFIFG-NMI interrupt during changing the SELM/SELS/SELA bits in the UCSCTL4 register to prevent unintended NMI. Alternatively it can be handled accordingly (clear falsely set fault flags) in the Interrupt

Service Routine to ensure proper OFIFG clearing.

USCI26 USCI Module

**Category** Functional

**Function** Tbuf parameter violation in I2C multi-master mode

**Description** In multi-master I2C systems the timing parameter Tbuf (bus free time between a stop

condition and the following start) is not guaranteed to match the I2C specification of 4.7us in standard mode and 1.3us in fast mode. If the UCTXSTT bit is set during a running I2C



transaction, the USCI module waits and issues the start condition on bus release causing the violation to occur.

Note: It is recommended to check if UCBBUSY bit is cleared before setting UCTXSTT=1.

Workaround None

USCI31 USCI Module

Category Functional

Framing Error after USCI SW Reset (UCSWRST)

**Description** While receiving a byte over USCI-UART (with UCBUSY bit set), if the application resets the USCI module (software reset via UCSWRST), then a framing error is reported for the

next receiving byte.

Workaround 1. If possible, do not reset USCI-UART during an ongoing receive operation; that is, when

UCBUSY bit is set.

2. If the application software resets the USCI module (via the UCSWRST bit) during an ongoing receive operation, then set and reset the UCSYNC bit before releasing the

software USCI reset.

Workaround code sequence:

bis #UCSWRST, &UCAxCTL1; USCI SW reset

;Workaround begins

bis #UCSYNC, &UCAxCTL0; set synchronous mode bic #UCSYNC, &UCAxCTL0; reset synchronous mode

:Workaround ends

bic #UCSWRST, &UCAxCTL1; release USCI reset

USCI34 USCI Module

**Category** Functional

**Function** I2C multi-master transmit may lose first few bytes.

**Description** In an I2C multi-master system (UCMM =1), under the following conditions:

(1)the master is configured as a transmitter (UCTR =1)

**AND** 

(2)the start bit is set (UCTXSTT =1);

if the I2C bus is unavailable, then the USCI module enters an idle state where it waits and checks for bus release. While in the idle state it is possible that the USCI master updates its TXIFG based on clock line activity due to other master/slave communication on the bus. The data byte(s) loaded in TXBUF while in idle state are lost and transmit pointers

initialized by the user in the transmit ISR are updated incorrectly.

Workaround Verify that the START condition has been sent (UCTXSTT =0) before loading TXBUF with

data.

Example:

#pragma vector = USCIAB0TX\_VECTOR



```
__interrupt void USCIABOTX_ISR(void)
{
// Workaround for USCI34
if(UCBOCTL1&UCTXSTT)
{
// TXData = pointer to the transmit buffer start
// PTxData = pointer to transmit in the ISR
PTxData = TXData; // restore the transmit buffer pointer if the Start bit is set
}
//
if(IFG2&UCBOTXIFG)
{
if (PTxData < = PTxDataEnd) // Check TX byte counter
{
UCBOTXBUF = *PTxData++; // Load TX buffer
}
else
{
UCBOCTL1 |= UCTXSTP; // I2C stop condition
IFG2 &= ~UCBOTXIFG; // Clear USCI_BO TX int flag
__bic_SR_register_on_exit(CPUOFF); // Exit LPM0
}
}
```

## USCI35 USCI Module

Category

**Functional** 

**Function** 

Violation of setup and hold times for (repeated) start in I2C master mode

**Description** 

In I2C master mode, the setup and hold times for a (repeated) START,  $t_{SU,STA}$  and  $t_{HD,STA}$  respectively, can be violated if SCL clock frequency is greater than 50kHz in standard mode (100kbps). As a result, a slave can receive incorrect data or the I2C bus can be stalled due to clock stretching by the slave.

Workaround

If using repeated start, ensure SCL clock frequencies is < 50kHz in I2C standard mode (100 kbps).

### USCI39

#### **USCI** Module

Category

**Functional** 

**Function** 

USCI I2C IFGs UCSTTIFG, UCSTPIFG, UCNACKIFG

**Description** 

Unpredictable code execution can occur if one of the hardware-clear-able IFGs UCSTTIFG, UCSTPIFG or UCNACKIFG is set while the global interrupt enable is set by software (GIE=1). This erratum is triggered if ALL of the following events occur in following order:

- 1. Pending Interrupt: One of the UCxIFG=1 AND UCxIE=1 while GIE=0
- 2. The GIE is set by software (e.g. EINT)
- 3. The pending interrupt is cleared by hardware (external I2C event) in a time window of 1 MCLK clock cycle after the "EINT" instruction is executed.



Workaround

Disable the UCSTTIE, UCSTPIE and UCNACKIE before the GIE is set. After GIE is set, the local interrupt enable flags can be set again.

Assembly example:

bic #UCNACKIE+UCSTPIE+UCSTTIE, UCBxIE; disable all self-clearing interrupts

NOP EINT

bis #UCNACKIE+UCSTPIE+UCSTTIE, UCBxIE; enable all self-clearing interrupts

USCI40 USCI Module

**Category** Functional

**Function** SPI Slave Transmit with clock phase select = 1

**Description** In SPI slave mode with clock phase select set to 1 (UCAxCTLW0.UCCKPH=1), after the

first TX byte, all following bytes are shifted by one bit with shift direction dependent on UCMSB. This is due to the internal shift register getting pre-loaded asynchronously when writing to the USCIA TXBUF register. TX data in the internal buffer is shifted by one bit

after the RX data is received.

**Workaround** Reinitialize TXBUF before using SPI and after each transmission.

If transmit data needs to be repeated with the next transmission, then write back

previously read value:

UCAxTXBUF = UCAxTXBUF;

www.ti.com Revision History

## 7 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

C	Changes from February 20, 2020 to May 11, 2021								
•	Changed the document format and structure: undated the numbering format for tables	figure							

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